



N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A) ^a	Q _g (Typ.)			
30	0.0033 at V _{GS} = 10 V	30	37 nC			
30	0.0041 at V _{GS} = 4.5 V	26.3	37 110			

SO-8 S 1 S 2 T D S 3

Ordering Information: Si4626ADY-T1-E3 (Lead (Pb)-free)

Top View

G

Si4626ADY-T1-GE3 (Lead (Pb)-free and Halogen-free)

D

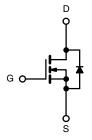
FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET[®] Power MOSFET
- 100 % R_g and UIS Tested

ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

- Low-Side DC/DC Conversion
 - Notebook
 - Gaming



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted						
Parameter		Symbol	Limit	Unit		
Drain-Source Voltage		V_{DS}	30	V		
Gate-Source Voltage		V _{GS}	± 20	ľ		
	T _C = 25 °C		30			
Continuous Drain Current (T _{.I} = 150 °C)	$T_C = 70 ^{\circ}C$	I _D	22.6			
Commission Plant Carrott (1) = 100 0)	T _A = 25 °C	J .0	21.5 ^{b, c}			
	T _A = 70 °C	1	17.1 ^{b, c}	Α		
Pulsed Drain Current		I _{DM}	70	A		
Continuous Source-Drain Diode Current	T _C = 25 °C	I _S	5.4			
Communication Control of the Control	T _A = 25 °C	'S	2.7 ^{b, c}			
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	40			
Avalanche Energy		E _{AS}	80	mJ		
	T _C = 25 °C		6.0			
Maximum Power Dissipation	$T_C = 70 ^{\circ}C$	P _D	3.3	W		
Maximum i ower bissipation	T _A = 25 °C		3.0 ^{b, c}			
	T _A = 70 °C		1.9 ^{b, c}			
Operating Junction and Storage Temperature	e Range	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R_{thJA}	33	42	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	16	21	C/ VV		

Notes:

- a. Based on T_C = 25 °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under Steady State conditions is 85 $^{\circ}\text{C/W}.$

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	30			٧	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J. 050A		37		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	- I _D = 250 μA		- 7.3			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = 250 \mu A$	1.2		2.5	٧	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zava Cata Valtaga Duais Courset	-	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			1	μΑ	
Zero Gate Voltage Drain Current	I _{DSS}				10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α	
		V _{GS} = 10 V, I _D = 15 A		0.0026	0.0033		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 10 A		0.0032	0.0041	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		85		S	
Dynamic ^b					l		
Input Capacitance	C _{iss}			5370			
Output Capacitance	C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		690		pF	
Reverse Transfer Capacitance	C _{rss}			330			
•		V _{DS} = 15 V, V _{GS} = 10 V, I _D = 10 A		82	125	nC	
Total Gate Charge	Q_g			37	56		
Gate-Source Charge	Q_{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		12.6			
Gate-Drain Charge	Q _{gd}			9.8			
Gate Resistance	R_{g}	f = 1 MHz	0.2	0.95	1.9	Ω	
Turn-On Delay Time	t _{d(on)}			44	70		
Rise Time	t _r	$V_{DD} = 15 \text{ V}, R_L = 3 \Omega$		21	35		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 5 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		45	70		
Fall Time	t _f			18	30		
Turn-On Delay Time	t _{d(on)}			15	30	ns	
Rise Time	t _r	$V_{DD} = 15 \text{ V}, R_L = 3 \Omega$		10	20		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 5 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		43	70		
Fall Time	t _f			8	15		
Drain-Source Body Diode Characteristi	cs						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			5.4		
Pulse Diode Forward Current ^a	I _{SM}				70	Α	
Body Diode Voltage	V _{SD}	I _S = 2.7 A		0.74	1.1	V	
Body Diode Reverse Recovery Time	t _{rr}			38	60	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	1		36	60	nC	
Reverse Recovery Fall Time	t _a	$I_F = 5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		20		1	
Reverse Recovery Rise Time	t _b			18		ns	

Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

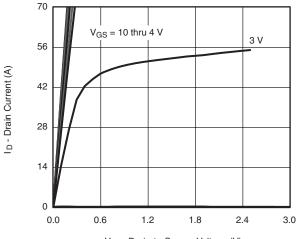
a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing.



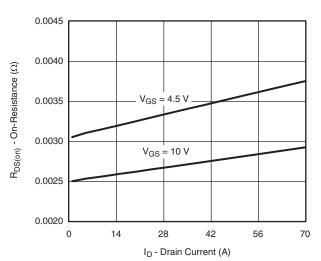
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

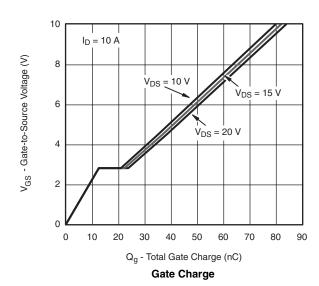


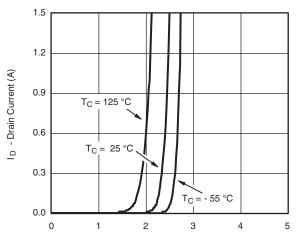
V_{DS} - Drain-to-Source Voltage (V)

Output Characteristics



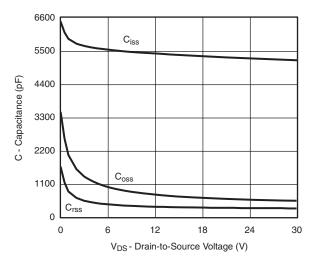
On-Resistance vs. Drain Current and Gate Voltage



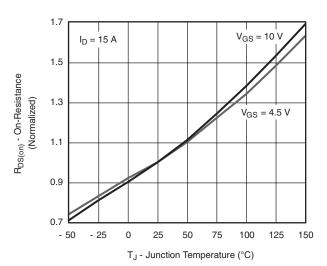


V_{GS} - Gate-to-Source Voltage (V)





Capacitance

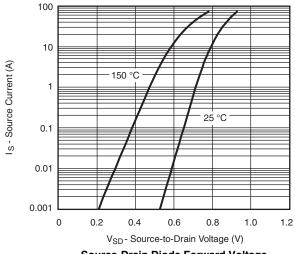


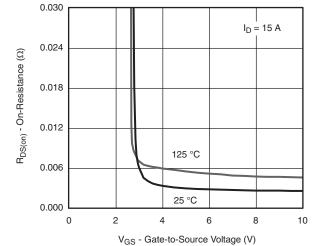
On-Resistance vs. Junction Temperature

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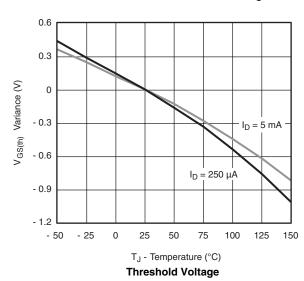
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

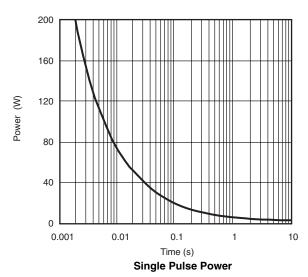


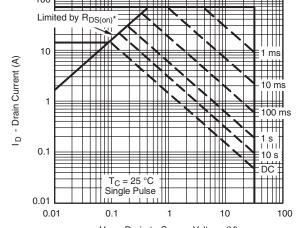


Source-Drain Diode Forward Voltage









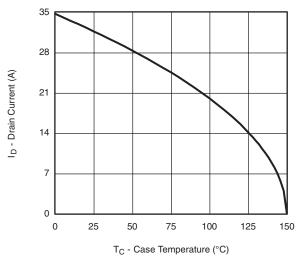
V_{DS} - Drain-to-Source Voltage (V) * V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

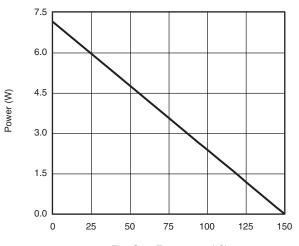
Safe Operating Area, Junction-to-Ambient



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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

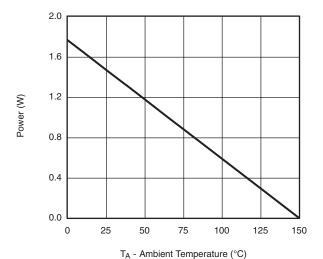




T_C - Case Temperature (°C)

Current Derating*

Power Derating, Junction-to-Foot



Power, Junction-to-Ambient

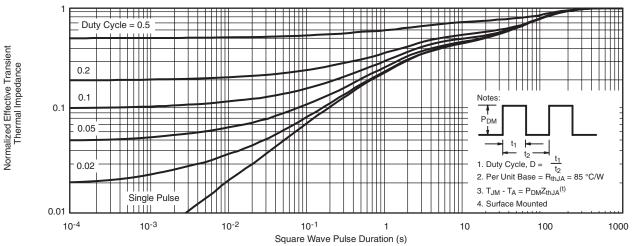
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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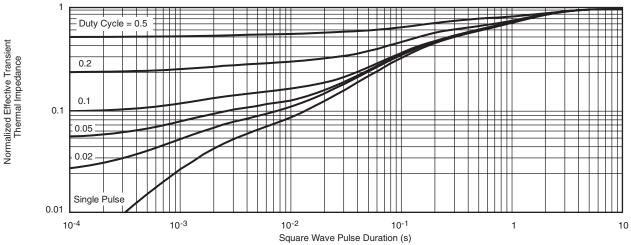
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27 BSC		0.050	0.050 BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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